

- State-of-the-Art **EPIC-IITM** BiCMOS Design Significantly Reduces Power Dissipation
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce) < 1 V at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$
- High-Impedance State During Power Up and Power Down
- Designed to Facilitate Incident-Wave Switching for Line Impedances of 25 Ω or Greater
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include Plastic Small-Outline (DW) Package, Ceramic Chip Carriers (FK), and Standard Plastic (NT) and Ceramic (JT) DIPs

description

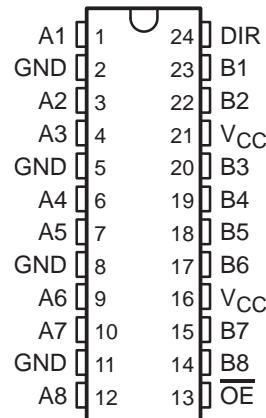
The 'ABTH25245 are 25- Ω octal bus transceivers designed for asynchronous communication between data buses. They improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented transceivers.

These devices allow noninverted data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can disable the device so that both buses are effectively isolated. When \overline{OE} is low, the device is active.

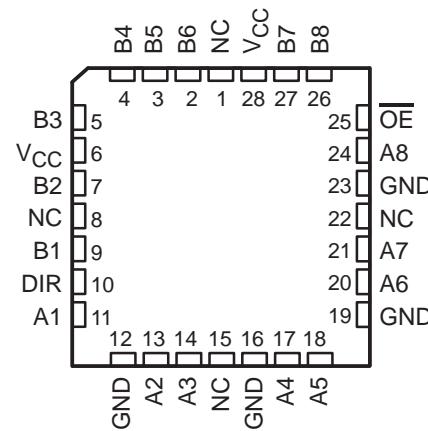
These transceivers are capable of sinking 188 mA of I_{OL} current, which facilitates switching 25- Ω transmission lines on the incident wave. The distributed V_{CC} and GND pins minimize switching noise for more-reliable system operation.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

SN54ABTH25245 . . . JT PACKAGE
 SN74ABTH25245 . . . DW OR NT PACKAGE
 (TOP VIEW)



SN54ABTH25245 . . . FK PACKAGE
 (TOP VIEW)



NC – No internal connection



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**SN54ABTH25245, SN74ABTH25245
25- Ω OCTAL BUS TRANSCEIVERS
WITH 3-STATE OUTPUTS**

SCBS251F – JUNE 1992 – REVISED MAY 1997

description (continued)

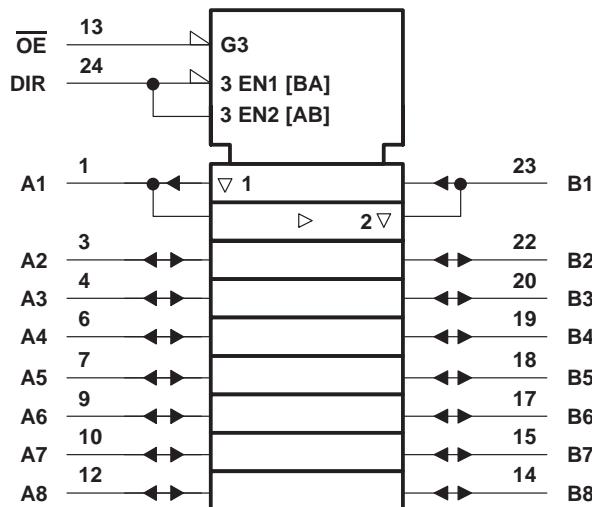
When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABTH25245 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74ABTH25245 is characterized for operation from -40°C to 85°C .

FUNCTION TABLE

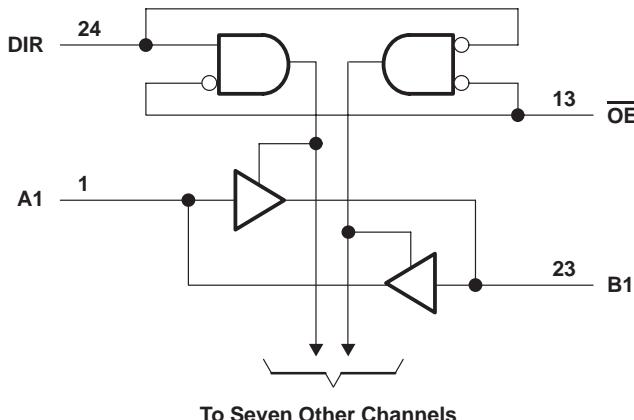
INPUTS		OPERATION
\overline{OE}	DIR	
L	L	B data to A bus
L	H	A data to B bus
H	X	Isolation

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the DW, JT, and NT packages.

logic diagram (positive logic)



Pin numbers shown are for the DW, JT, and NT packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51, except for through-hole packages, which use a trace length of zero.

**SN54ABTH25245, SN74ABTH25245
25- Ω OCTAL BUS TRANSCEIVERS
WITH 3-STATE OUTPUTS**

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recommended operating conditions (see Note 3)

		SN54ABTH25245		SN74ABTH25245		UNIT
		MIN	MAX	MIN	MAX	
V _{CC}	Supply voltage	4.5	5.5	4.5	5.5	V
V _{IH}	High-level input voltage	2		2		V
V _{IL}	Low-level input voltage		0.8		0.8	V
V _I	Input voltage	0	V _{CC}	0	V _{CC}	V
I _{IK}	Input clamp current		-18		-18	mA
I _{OH}	High-level output current	A port		-80	-80	mA
		B port		-32	-32	
I _{OL}	Low-level output current	A port		188	188	mA
		B port		64	64	
$\Delta t/\Delta V$	Input transition rise or fall rate	Outputs enabled	Control inputs	4	4	ns/V
			A or B ports	10	10	
$\Delta t/\Delta V_{CC}$	Power-up ramp rate			200	200	$\mu\text{s}/\text{V}$
T _A	Operating free-air temperature			-55	125	-40 85 °C

NOTE 3: Unused control pins must be held high or low to prevent them from floating.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS			SN54ABTH25245		SN74ABTH25245		UNIT	
					MIN	TYP [†]	MAX	MIN		
V _{IK}		V _{CC} = 4.5 V, I _I = -18 mA					-1.2	-1.2	V	
V _{OH}	A port	V _{CC} = 4.75 V, I _{OH} = -3 mA			2.7		2.7		V	
		V _{CC} = 4.5 V, I _{OH} = -80 mA			2.4		2.4			
	B port	V _{CC} = 4.5 V, I _{OH} = -3 mA			2.5		2.5			
		V _{CC} = 5 V, I _{OH} = -3 mA			3		3			
V _{OL}	A port	V _{CC} = 4.5 V	I _{OL} = 94 mA			0.55		0.55	V	
			I _{OL} = 188 mA			0.7		0.7		
B port		V _{CC} = 4.5 V, I _{OL} = 64 mA				0.55*		0.55		
V _{hys}					100		100		mV	
I _I	Control inputs	V _{CC} = 0 to 5.5 V, V _I = V _{CC} or GND				±1		±1	μA	
	A or B ports	V _{CC} = 2.1 V to 5.5 V, V _I = V _{CC} or GND				±20		±20		
I _I (hold)	A or B ports	V _{CC} = 4.5 V	V _I = 0.8 V		100		100		μA	
			V _I = 2 V		-100		-100			
I _{OZPU} [‡]		V _{CC} = 0 to 2.1 V, V _O = 0.5 V to 2.7 V, OE = X				±50		±50	μA	
I _{OZPD} [‡]		V _{CC} = 2.1 V to 0, V _O = 0.5 V to 2.7 V, OE = X				±50		±50	μA	
I _{off}		V _{CC} = 0, V _I or V _O ≤ 4.5 V				±100		±100	μA	
I _{CEX}		V _{CC} = 5.5 V, V _O = 5.5 V				50		50	μA	
I _O [§]	B port	V _{CC} = 5.5 V, V _O = 2.5 V			-50	-210	-50	-210	mA	
I _{CC}		V _{CC} = 5.5 V, Outputs open, V _I = V _{CC} or GND	Outputs high			500		500	μA	
			Outputs low			20		20	mA	
			Outputs disabled			500		500	μA	
ΔI _{CC} [¶]		V _{CC} = 5.5 V, One input at 3.4 V, Other inputs at V _{CC} or GND				1		1	mA	
C _i	Control inputs	V _{CC} = 5 V, V _I = V _{CC} or GND			4		4		pF	
C _{io}	A or B ports	V _{CC} = 5 V, V _O = V _{CC} or GND			11.5		11.5		pF	

* On products compliant to MIL-PRF-38535, this parameter does not apply.

† All typical values are at V_{CC} = 5 V, T_A = 25°C.

‡ This parameter is characterized, but not production tested.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

**SN54ABTH25245, SN74ABTH25245
25- Ω OCTAL BUS TRANSCEIVERS
WITH 3-STATE OUTPUTS**

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switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

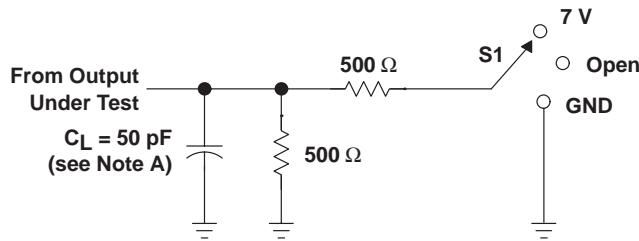
PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 5 \text{ V}$, $T_A = 25^\circ\text{C}$			SN54ABTH25245		SN74ABTH25245		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	A or B	B or A	1	2.3	3.5	1		1	3.9	ns
t_{PHL}			1	2.4	3.5	1		1	4.3	
t_{PZH}	\overline{OE}	A or B	1.5	3.7	5.4	1.5		1.5	6.5	ns
t_{PZL}			1.4	4	5.8	1.4		1.4	6.8	
t_{PHZ}	\overline{OE}	A or B	2	4.3	6.1	2		2	7.2	ns
t_{PLZ}			2	3.9	5.8	2		2	6.4	

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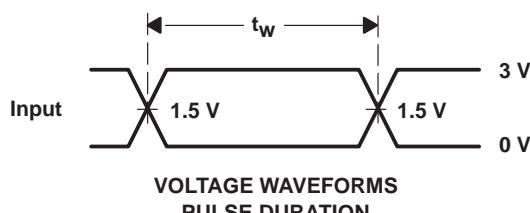
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PARAMETER MEASUREMENT INFORMATION

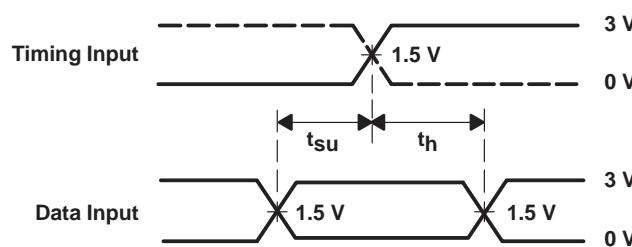


TEST	S1
tPLH/tPHL	Open
tPLZ/tPZL	7 V
tPHZ/tPZH	Open

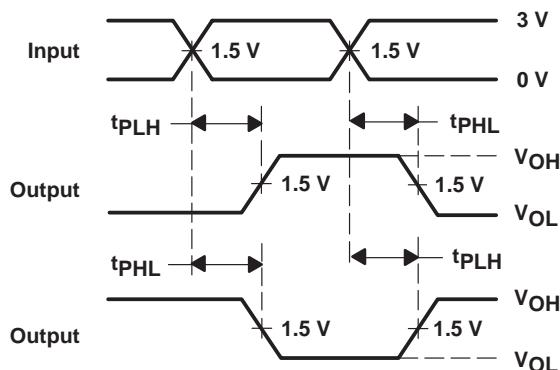
LOAD CIRCUIT



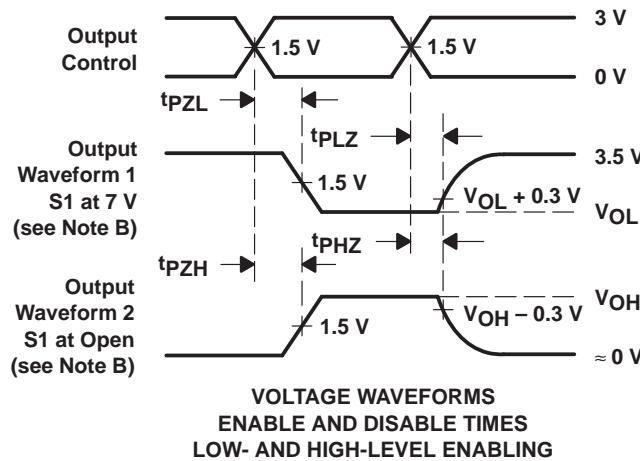
VOLTAGE WAVEFORMS
 PULSE DURATION



VOLTAGE WAVEFORMS
 SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
 PROPAGATION DELAY TIMES
 INVERTING AND NONINVERTING OUTPUTS

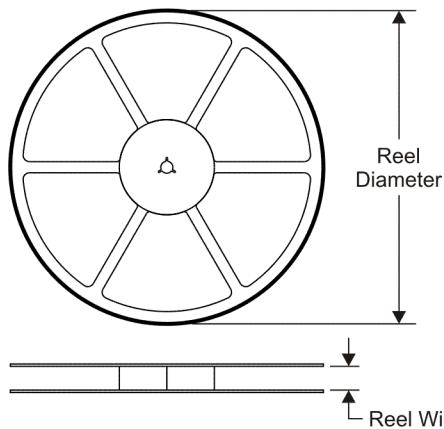
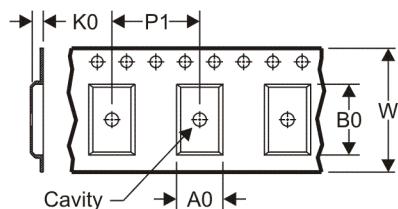


VOLTAGE WAVEFORMS
 ENABLE AND DISABLE TIMES
 LOW- AND HIGH-LEVEL ENABLING

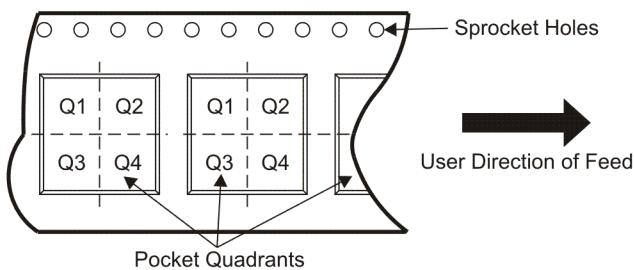
NOTES: A. C_L includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_r \leq 2.5$ ns, $t_f \leq 2.5$ ns.
 D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

TAPE AND REEL INFORMATION
REEL DIMENSIONS

TAPE DIMENSIONS


A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ABTH25245DWR	SOIC	DW	24	2000	330.0	24.4	10.75	15.7	2.7	12.0	24.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ABTH25245DWR	SOIC	DW	24	2000	346.0	346.0	41.0

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